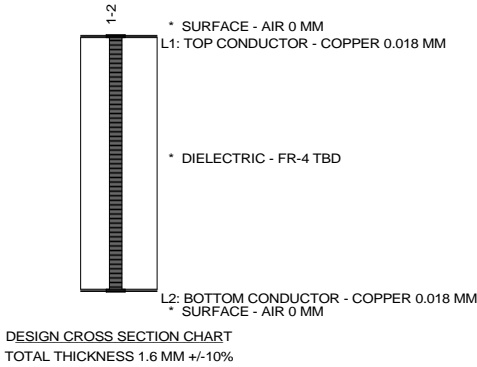
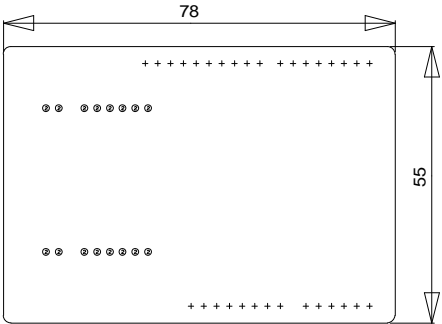

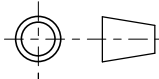


ARTWORKS	LAYER Nb	PCB	REV.	TYPE
TOP LAYER	1	OM29110ARD	00	311
INT. 1 LAYER	-	-	00	311
INT. 2 LAYER	-	-	00	311
INT. 3 LAYER	-	-	-	311
INT. 4 LAYER	-	-	-	311
INT. 5 LAYER	-	-	-	311
INT. 6 LAYER	-	-	-	311
INT. 7 LAYER	-	-	-	311
INT. 8 LAYER	-	-	-	311
BOTTOM LAYER	2	OM29110ARD	00	311
POWER_1	-	-	-	311
POWER_2	-	-	-	311
POWER_3	-	-	-	311
POWER_4	-	-	-	311
POWER_5	-	-	-	311
SOLDER MASK TOP	3	OM29110ARD	00	312
SOLDER MASK BOT	4	OM29110ARD	00	312
SILKSCREEN TOP	5	OM29110ARD	00	380
SILKSCREEN BOT	6	OM29110ARD	00	380
MILLING	7	OM29110ARD	00	313



DRILL CHART: TOP to BOTTOM				
ALL UNITS ARE IN MILLIMETERS				
FIGURE	SIZE	TOLERANCE	PLATED	QTY
+	1.1	+0.1/-0.05	PLATED	32
⌀	1.4	+0.0/-0.0	PLATED	16

Date	Draw by	Verify	Modifications	IND.		
Date : 18-11-2015  Draw by : ASCO_SR  Checked by: J.GESLIN  Project : OM29110ARD		Material:FR4 TG150 LOW CTEz 16/10 17.5 uM of basic	Marging : +/-0.1	Nbr of layers : 2		
		Finition : Ni/Au chemical	Manufact.level : 5	Silkscreen  TOP :YES BOTTOM:NO		
		Protection : SOLDERMASK  TOP BOTTOM	Scale : 1/1			
NXP Semiconductors 2,Esplanade Anton Philips Campus Effiscience Colombelles BP 2000 - 14906 CAEN CEDEX 9			  All rights are reserved. Reproduction in whole or in part is prohibited without the written consent of the copyright owner			
DRILL MANUFACTURING Arduino Interface Board			SIZE A3	OM29110ARD-300	REV. 00	PL. 1 / 1